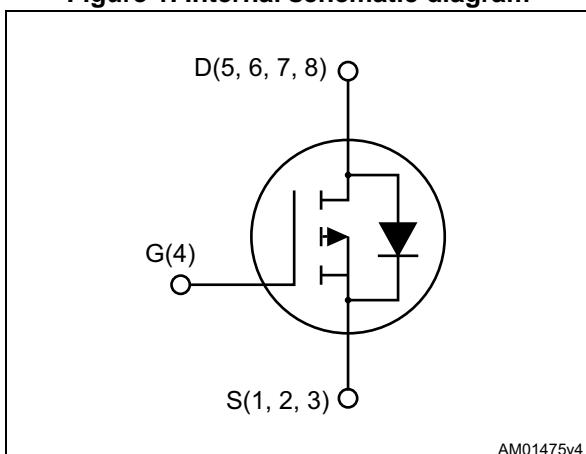


## P-channel 60 V, 0.13 Ω typ., 12 A STripFET™ F6 Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - production data



**Figure 1. Internal schematic diagram**



## Features

Order code	V <sub>DS</sub>	R <sub>DS(on)max</sub>	I <sub>D</sub>
STL12P6F6	60 V	0.16 Ω @ 10 V	12 A

- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

## Applications

- Switching applications

## Description

This device is an P-channel Power MOSFET developed using the STripFET™ F6 technology, with a new trench gate structure. The resulting Power MOSFET exhibits a very low R<sub>DS(on)</sub> in all packages.

**Table 1. Device summary**

Order code	Marking	Package	Packaging
STL12P6F6	12P6F6	PowerFLAT 5x6	Tape and reel

**Note:** For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.

## Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	60	V
$V_{GS}$	Gate-source voltage	$\pm 20$	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	12	A
$I_D^{(1)}$	Drain current (continuous) at $T_C = 100^\circ\text{C}$	8.5	A
$I_{DM}^{(1)(2)}$	Drain current (pulsed)	48	A
$I_D^{(3)}$	Drain current (continuous) at $T_{pcb} = 25^\circ\text{C}$	4	A
$I_D^{(3)}$	Drain current (continuous) at $T_{pcb} = 100^\circ\text{C}$	2.8	A
$P_{TOT}^{(1)}$	Total dissipation at $T_C = 25^\circ\text{C}$	75	W
$P_{TOT}^{(3)}$	Total dissipation at $T_{pcb} = 25^\circ\text{C}$	4.8	W
$T_j$	Operating junction temperature	-55 to 175	$^\circ\text{C}$
$T_{stg}$	Storage temperature		$^\circ\text{C}$

1. The value is according to  $R_{thj\text{-case}}$
2. Pulse width is limited by safe operating area.
3. The value is according to  $R_{thj\text{-pcb}}$

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj\text{-case}}$	Thermal resistance junction-case max	2	$^\circ\text{C/W}$
$R_{thj\text{-pcb}}^{(1)}$	Thermal resistance junction-pcb max	31.3	$^\circ\text{C/W}$

1. When mounted on FR-4 board of 15 mm<sup>2</sup>, 2 Oz Cu, t<10 sec

**Note:** For the P-channel Power MOSFET actual polarity of voltages and current has to be reversed.

## 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified).

**Table 4. On /off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	V <sub>GS</sub> = 0, I <sub>D</sub> = 250 µA	60			V
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>GS</sub> = 0, V <sub>DS</sub> = 60 V			1	µA
		V <sub>GS</sub> = 0, V <sub>DS</sub> = 60 V, T <sub>C</sub> =125 °C			10	µA
I <sub>GSS</sub>	Gate-body leakage current	V <sub>DS</sub> = 0, V <sub>GS</sub> = ± 20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 µA	2		4	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.5 A		0.13	0.16	Ω

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C <sub>iss</sub>	Input capacitance	V <sub>GS</sub> = 0, V <sub>DS</sub> = 48 V, f = 1 MHz	-	340	-	pF
C <sub>oss</sub>	Output capacitance		-	40	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	20	-	pF
Q <sub>g</sub>	Total gate charge	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 3 A, V <sub>GS</sub> = 10 V (see <i>Figure 14</i> )	-	6.4	-	nC
Q <sub>gs</sub>	Gate-source charge		-	1.7	-	nC
Q <sub>gd</sub>	Gate-drain charge		-	1.7	-	nC

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 48 V, I <sub>D</sub> = 1.5 A, R <sub>G</sub> = 4.7 Ω, V <sub>GS</sub> = 10 V (see <i>Figure 13</i> )	-	64	-	ns
t <sub>r</sub>	Rise time		-	5.3	-	ns
t <sub>d(off)</sub>	Turn-off delay time		-	14	-	ns
t <sub>f</sub>	Fall time		-	3.7	-	ns

Note: For the P-channel Power MOSFET actual polarity of voltages and current has to be reversed.

**Table 7. Source drain diode**

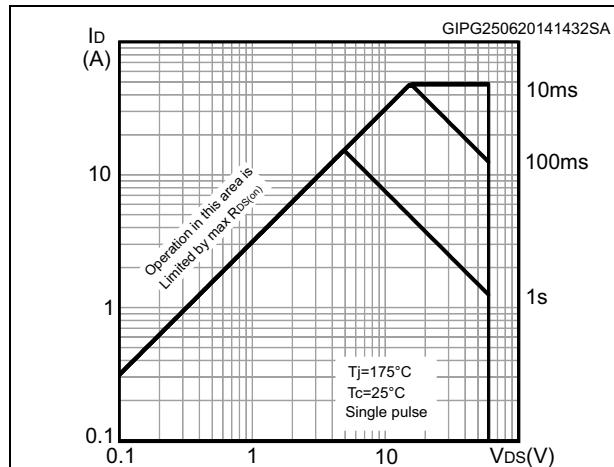
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$ $I_{SDM}^{(1)}$	Source-drain current Source-drain current (pulsed)		-		12 48	A A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0$ , $I_{SD} = 3$ A	-		1.1	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 5$ A, $di/dt = 100$ A/ $\mu$ s $V_{DD} = 16$ V, $T_j = 150$ °C (see <a href="#">Figure 15</a> )	-	20		ns
$Q_{rr}$	Reverse recovery charge		-	17.8		nC
$I_{RRM}$	Reverse recovery current		-	1.8		A

1. Pulse width limited by safe operating area.
2. Pulse duration = 300  $\mu$ s, duty cycle 1.5%

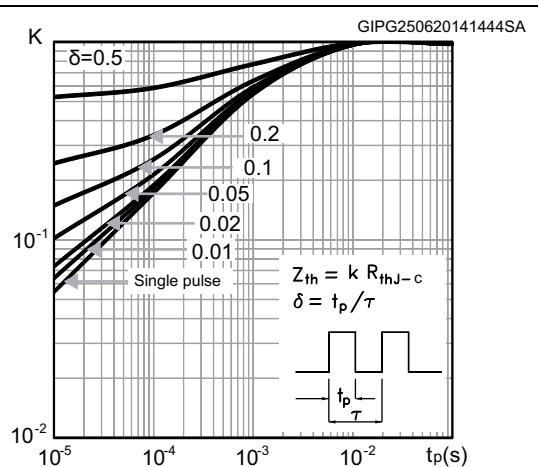
**Note:** For the P-channel Power MOSFET actual polarity of voltages and current has to be reversed.

## 2.1 Electrical characteristics (curves)

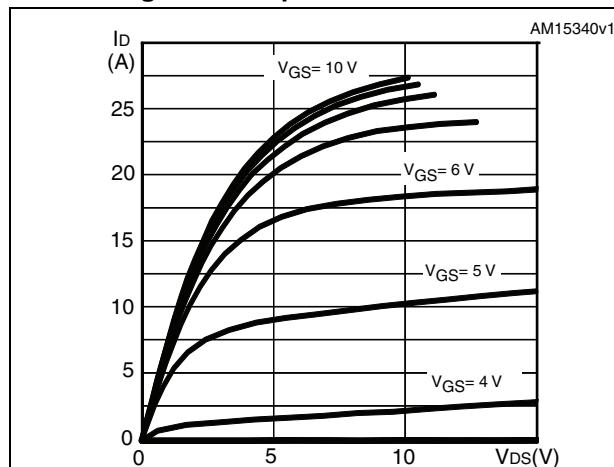
**Figure 2. Safe operating area**



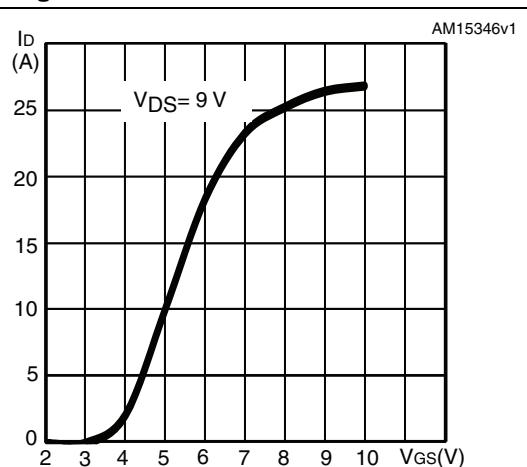
**Figure 3. Thermal impedance**



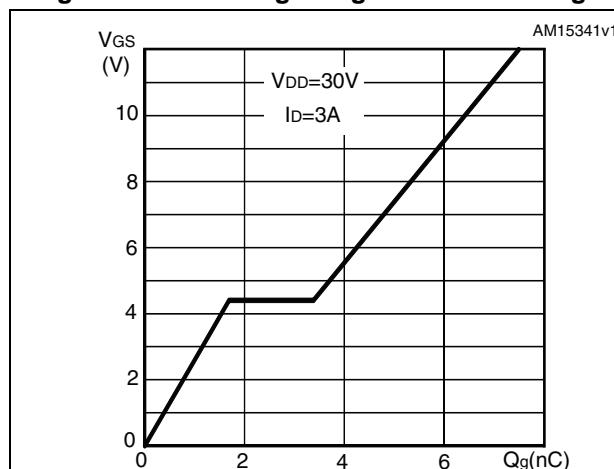
**Figure 4. Output characteristics**



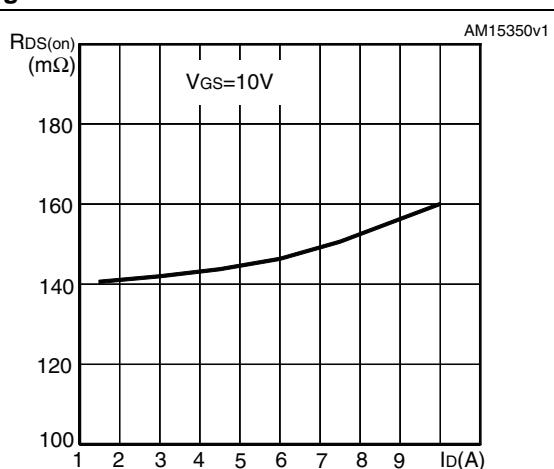
**Figure 5. Transfer characteristics**

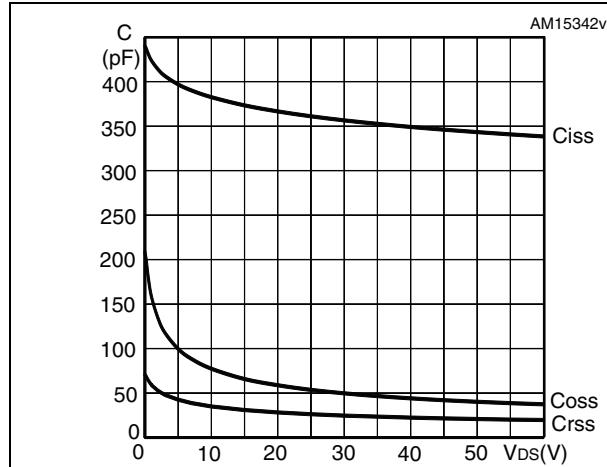
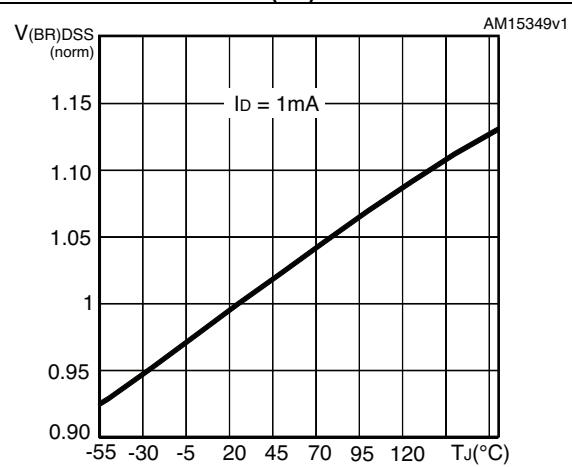
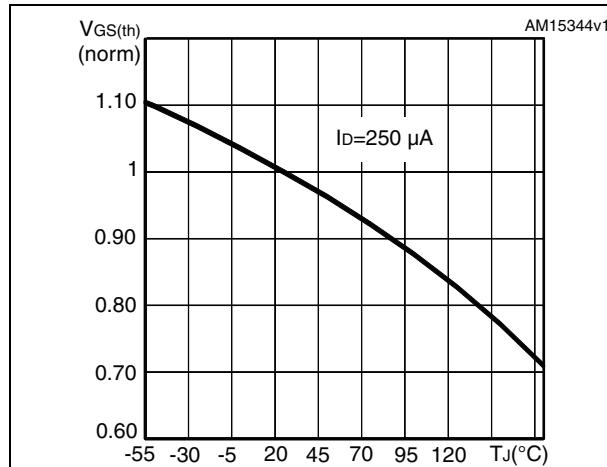
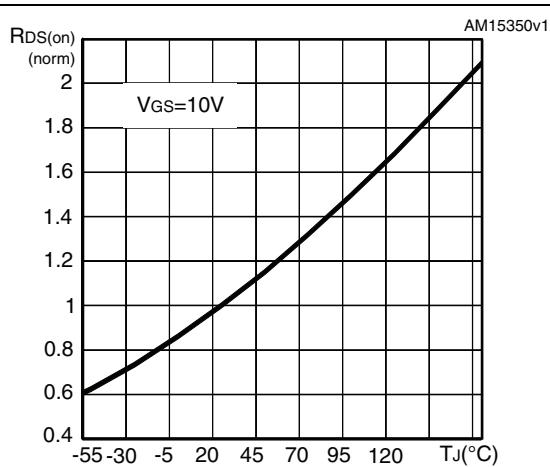
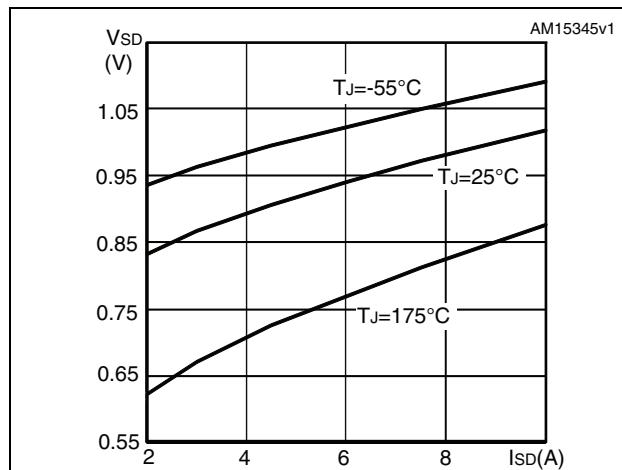


**Figure 6. Gate charge vs gate-source voltage**



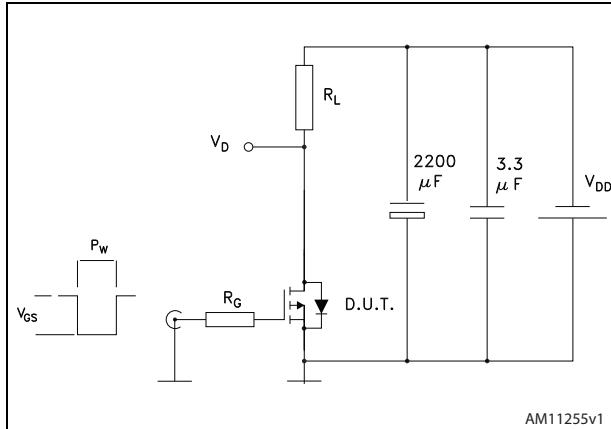
**Figure 7. Static drain-source on-resistance**



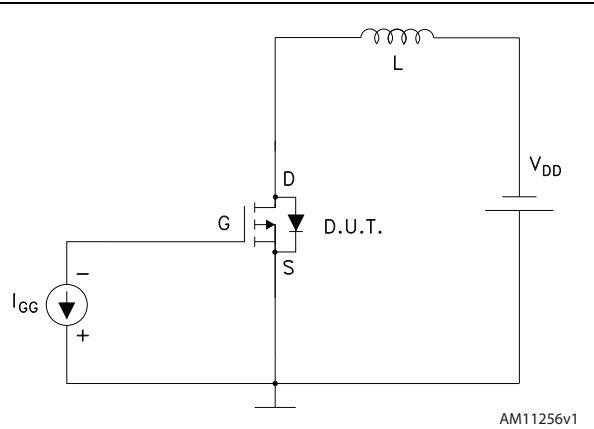
**Figure 8. Capacitance variations****Figure 9. Normalized V<sub>(BR)DSS</sub> vs temperature****Figure 10. Normalized gate threshold voltage vs temperature****Figure 11. Normalized on-resistance vs temperature****Figure 12. Source-drain diode forward characteristics**

### 3 Test circuits

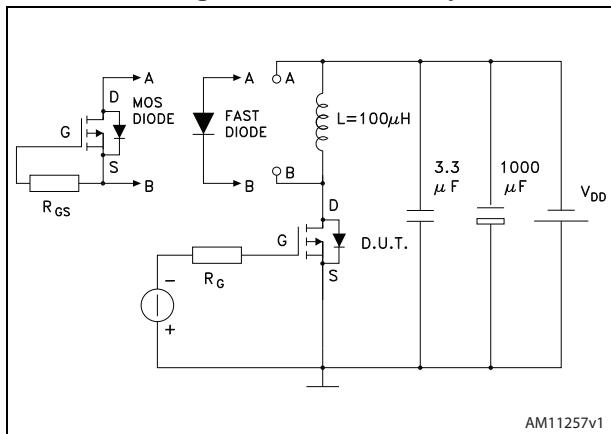
**Figure 13. Switching times test circuit for resistive load**



**Figure 14. Gate charge test circuit**

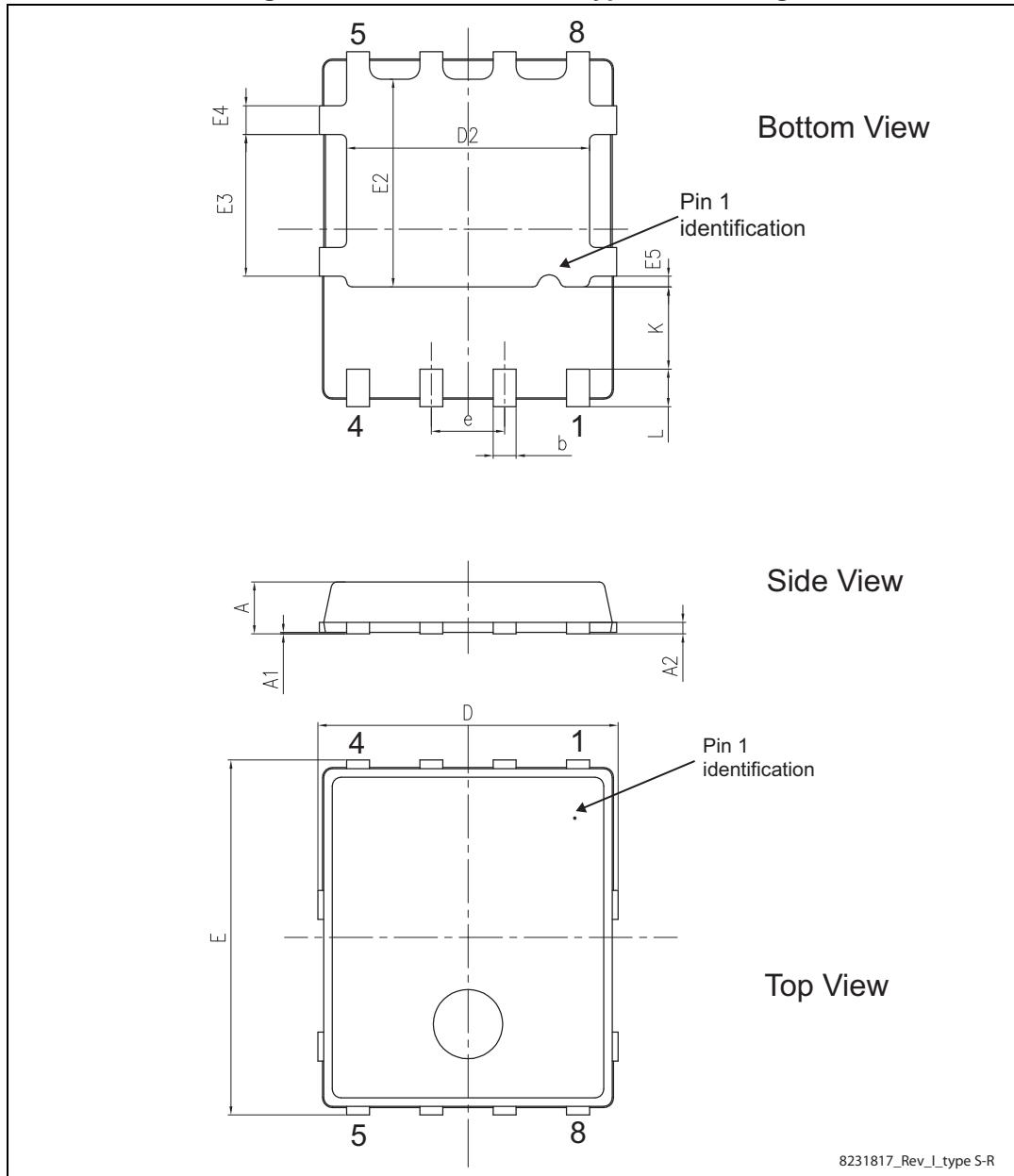


**Figure 15. Test circuit for inductive load switching and diode recovery times**



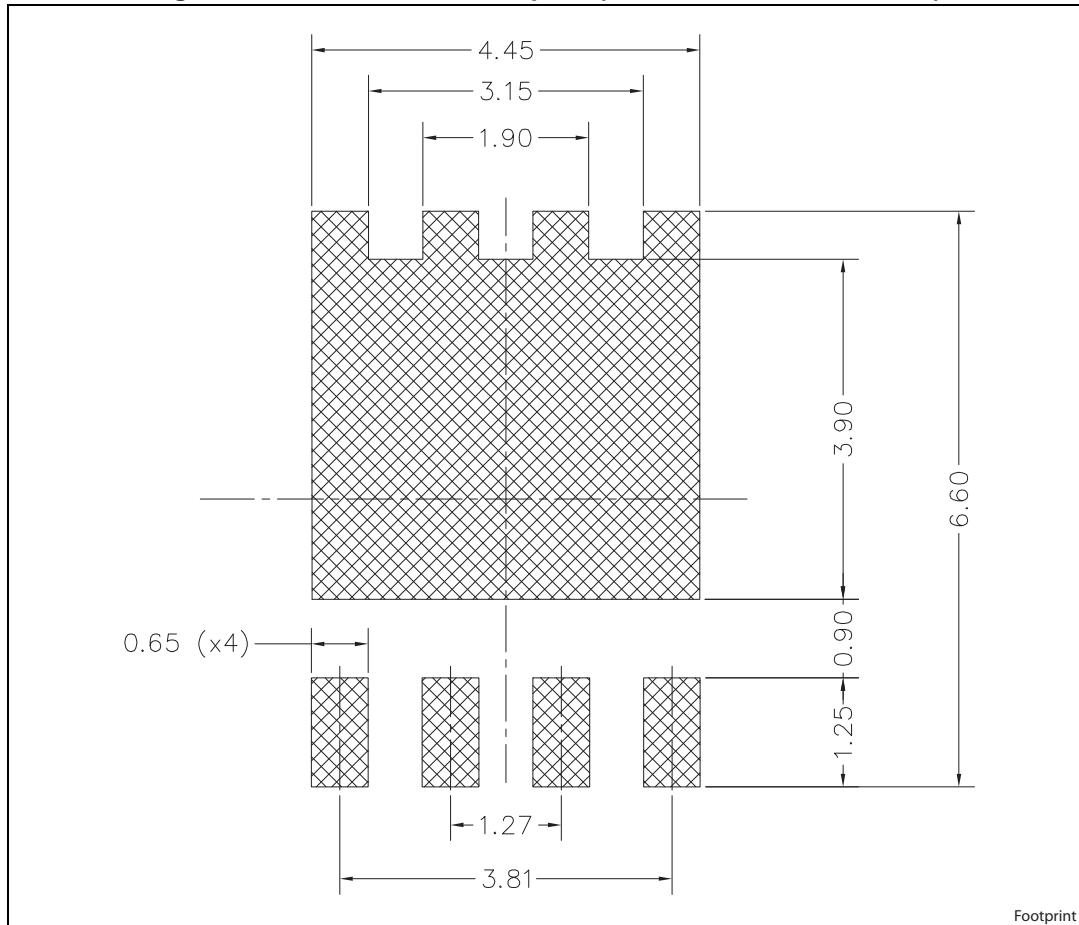
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

**Figure 16. PowerFLAT™ 5x6 type S-R drawing**

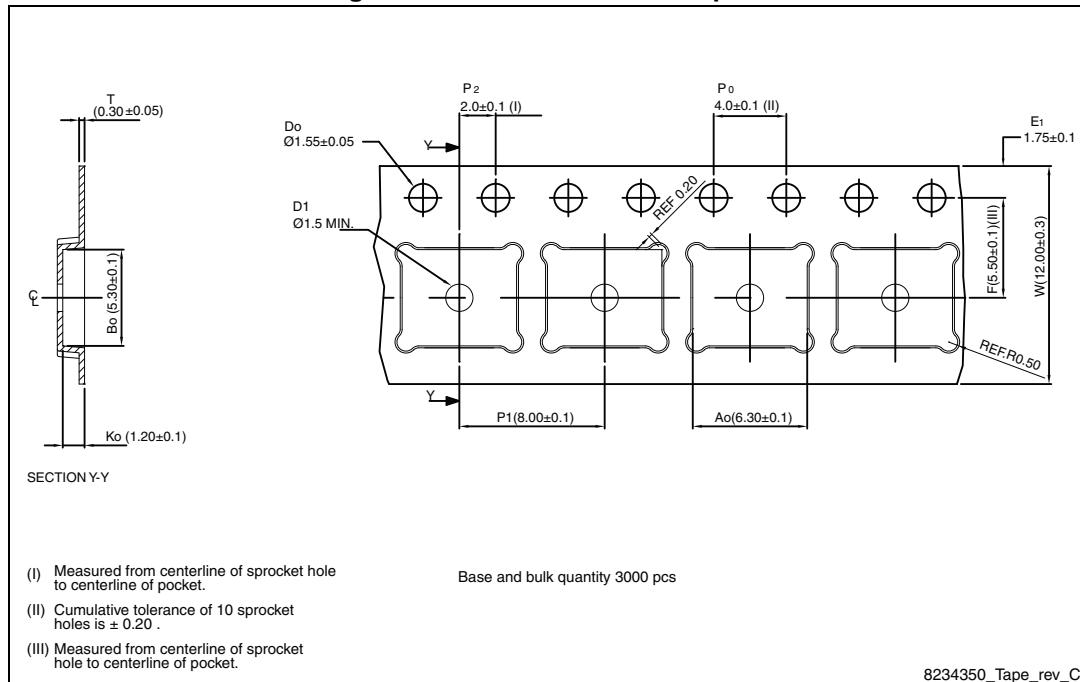
**Table 8. PowerFLAT 5x6 type S-R mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D	5.00	5.20	5.40
D2	4.11		4.31
E	5.95	6.15	6.35
e		1.27	
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
K	1.275		1.575
L	0.60		0.80

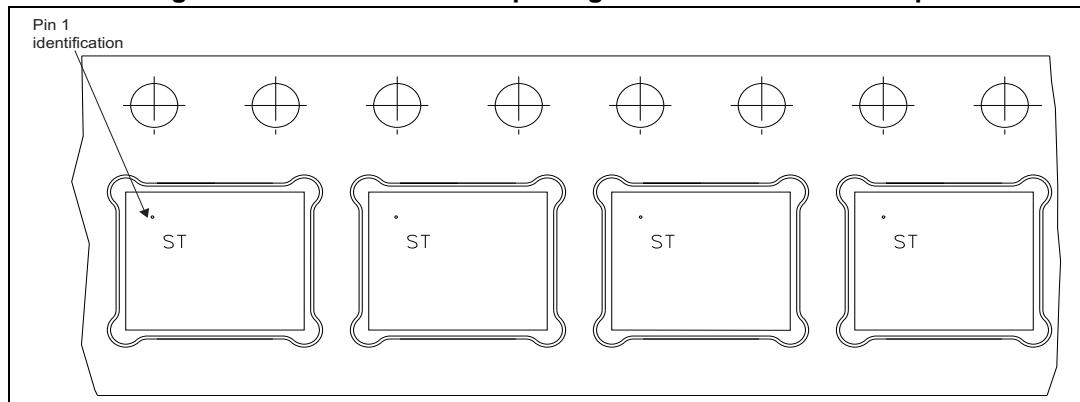
**Figure 17. Recommended footprint (dimensions in millimeters)**

## 5 Packaging mechanical data

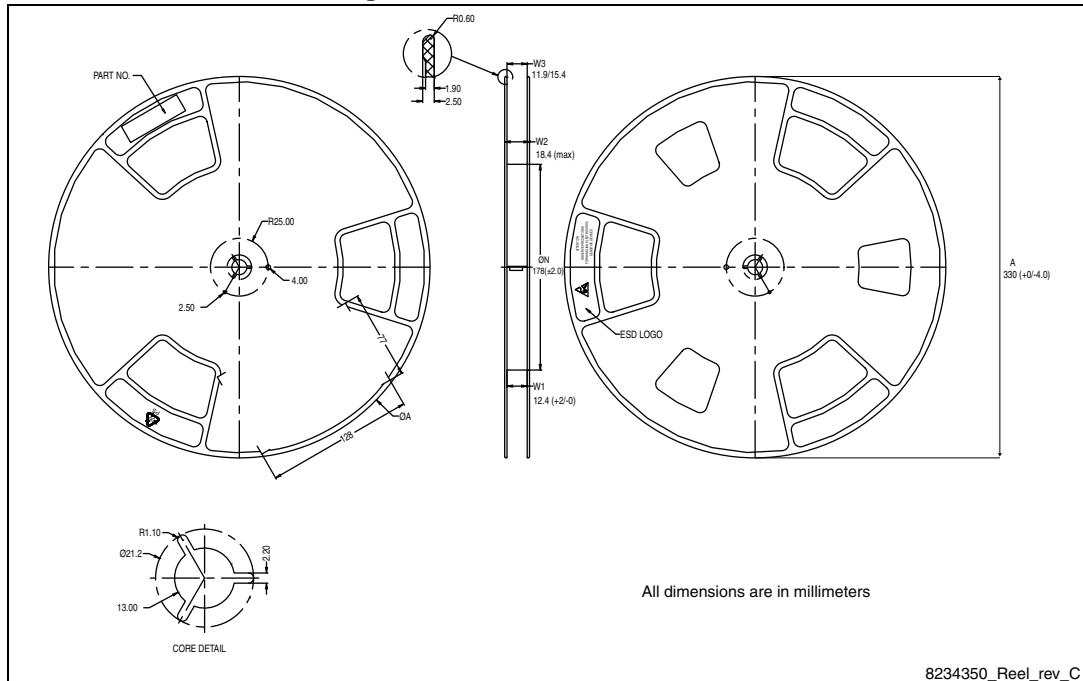
**Figure 18. PowerFLAT™ 5x6 tape<sup>(a)</sup>**



**Figure 19. PowerFLAT™ 5x6 package orientation in carrier tape**



a. All dimensions are in millimeters.

**Figure 20. PowerFLAT™ 5x6 reel**

## 6 Revision history

Table 9. Document revision history

Date	Revision	Changes
20-Mar-2013	1	First release.
14-Jul-2014	2	<ul style="list-style-type: none"><li>– Modified: <math>I_D</math>, and <math>I_{DM}</math> values in <a href="#">Table 2</a></li><li>– Modified: the entire typical values in <a href="#">Table 6</a></li><li>– Modified: <math>I_{SD}</math> and <math>I_{SDM}</math> max values in <a href="#">Table 7</a></li><li>– Added: <a href="#">Section 2.1: Electrical characteristics (curves)</a></li><li>– Updated: <a href="#">Section 4: Package mechanical data</a></li><li>– Minor text changes</li></ul>

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